

## TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

<b>Title of Invention</b>	<b>SEMICONDUCTOR CHIP CAPABLE OF IMPLEMENTING WIRE BONDING OVER ACTIVE CIRCUITS</b>				
<p>Application Number :</p> <p>Date :</p> <p>First Named Applicant:       Kun-Chih Wang</p> <p>Confirmation Number:</p> <p>Attorney Docket Number:    NAUP0559USA</p>					
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<table border="1"><tr><td>Submitted By:</td><td>Elec. Sign.</td></tr><tr><td>Winston Hsu Registered Number: 41,526</td><td>Winston Hsu</td></tr></table>		Submitted By:	Elec. Sign.	Winston Hsu Registered Number: 41,526	Winston Hsu
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Documents being submitted:	Files
us-fee-sheet	NAUP0559-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-declaration	NAUP0559-usdecl.xml us-declaration.dtd us-declaration.xsl
us-power-of-attorney-grant	NAUP0559-uspoat.xml us-power-of-attorney-grant.dtd us-power-of-attorney-grant.xsl
us-assignment	NAUP0559-usassn.xml us-assignment.xsl us-assignment.dtd NAUP0559ASS1.tif NAUP0559ASS2.tif
us-request	NAUP0559-usrequ.xml us-request.dtd us-request.xsl
us-declaration	NAUP0559DEC1.tif
us-declaration	NAUP0559DEC2.tif
application-body	NAUP0559-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd NAUP0559usa-01.tif NAUP0559usa-02.tif

Comments

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